STATEMENT UNDER 37 CFR 3.73(b)	
Applicant/Patent Owner: Hemant P. Mungekar et al.	
Application No./Patent No./Control No.: <u>10/660,813</u> Filed/Iss	ue Date: September 12, 2003
Entitled: Reactive Ion Etching For Semiconductor Device Feature Topography Modification	
_Applied Materials, Inc, acorpora	ation
	e: corporation, partnership, university, government agency, etc.)
states that it is:	
1. the assignee of the entire right, title, and interest; or	
an assignee of less than the entire right, title and interest.  (The extent (by percentage) of its ownership interest is%)	
in the patent application/patent identified above by virtue of either:	
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Additional documents in the chain of title are listed on a supplemental sheet.	
As required by 37 CFR 3.73(b)(1)(i), the documentary evidence of the chain of title from the original owner to the assignee was, or concurrently is being, submitted for recordation pursuant to 37 CFR 3.11.  [NOTE: A separate copy (i.e., a true copy of the original assignment document(s)) must be submitted to Assignment Division in accordance with 37 CFR Part 3, to record the assignment in the records of the USPTO. See MPEP 302.08[	
The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.	
/Jason A. Sanders/	May 5, 2008
Signature	Date
Jason A. Sanders, Reg. No. 59,984	303-571-4000
Printed or Typed Name	Telephone Number
Attorney of Record	
Title	